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**BUF634** 

www.burr-brown.com/databook/BUF634.html

# 250mA HIGH-SPEED BUFFER

#### **FEATURES**

- HIGH OUTPUT CURRENT: 250mA
- SLEW RATE: 2000V/µs
- PIN-SELECTED BANDWIDTH:
   30MHz to 180MHz
- LOW QUIESCENT CURRENT: 1.5mA (30MHz BW)
- WIDE SUPPLY RANGE: ±2.25 to ±18V
- INTERNAL CURRENT LIMIT
- THERMAL SHUTDOWN PROTECTION
- 8-PIN DIP, SO-8, 5-LEAD TO-220, 5-LEAD DDPAK SURFACE-MOUNT

#### **APPLICATIONS**

- VALVE DRIVER
- SOLENOID DRIVER
- OP AMP CURRENT BOOSTER
- LINE DRIVER
- HEADPHONE DRIVER
- VIDEO DRIVER
- MOTOR DRIVER
- TEST EQUIPMENT
- ATE PIN DRIVER

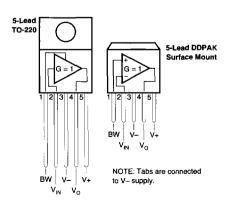
## **DESCRIPTION**

The BUF634 is a high speed unity-gain open-loop buffer recommended for a wide range of applications. It can be used inside the feedback loop of op amps to increase output current, eliminate thermal feedback and improve capacitive load drive.

For low power applications, the BUF634 operates on 1.5mA quiescent current with 250mA output, 2000V/µs slew rate and 30MHz bandwidth. Bandwidth can be adjusted from 30MHz to 180MHz by connecting a resistor between V- and the BW Pin.

Output circuitry is fully protected by internal current limit and thermal shut-down making it rugged and easy to use.

8-Pin DIP Package SO-8 Surface-Mount Package BW 1 8 NC NC 2 7 V+ V<sub>IN</sub> 3 G = 1 6 V<sub>O</sub> V- 4 5 NC The BUF634 is available in a variety of packages to suit mechanical and power dissipation requirements. Types include 8-pin DIP, SO-8 surface-mount, 5-lead TO-220, and a 5-lead DDPAK surface-mount plastic power package.



International Airport Industrial Park • Mailing Address: PO Box 11400, Tucson, AZ 85734 • Street Address: 6730 S. Tucson Bivd., Tucson, AZ 85706 • Tel: (\$20) 746-1111 • Twx: 910-952-1111 Internet: http://www.burr-brown.com/ • FAXLine: (800) 548-6133 (US/Canada Only) • Cable: BBRCORP • Telex: 056-6491 • FAX: (\$20) 889-1510 • Immediate Product Info: (800) 548-6132



## For Immediate Assistance, Contact Your Local Salesperson

## **SPECIFICATIONS**

#### **ELECTRICAL**

At  $T_A \approx +25^{\circ}C^{(1)}$ ,  $V_S = \pm 15V$ , unless otherwise noted.

		BUF634P, U, T, F					1	
		LOW QUIESCENT CURRENT MODE			WIDE BANDWIDTH MODE			1
PARAMETER	CONDITION	MIN	TYP	MAX	MIN	TYP	MAX	UNITS
INPUT Offset Voltage vs Temperature vs Power Supply Input Bias Current Input Impedance Noise Voltage	$\label{eq:Specified Temperature Range} \begin{split} \text{Specified Temperature Range} \\ V_S &= \pm 2.25 \text{V}^{(2)} \text{ to } \pm 18 \text{V} \\ V_{\text{IN}} &= 00 \text{V} \\ R_L &= 100 \Omega \\ f &= 10 \text{kHz} \end{split}$		±30 ±100 0.1 ±0.5 80    8	±100 1 ±2		* * * ±5 8 !! 8	* * ±20	mV μV/°C mV/V μA MΩ II pF nV/√Hz
GAIN	$R_L \approx 1k\Omega$ , $V_O = \pm 10V$ $R_L = 100\Omega$ , $V_O \approx \pm 10V$ $R_L \approx 67\Omega$ , $V_O = \pm 10V$	0.95 0.85 0.8	0.99 0.93 0.9		* *	* * *		V/V V/V
OUTPUT Current Output, Continuous Voltage Output, Positive Negative Positive Negative Positive Negative	$I_{O} = 10$ mA $I_{O} = -10$ mA $I_{O} = 100$ mA $I_{O} = -100$ mA $I_{O} = 150$ mA $I_{O} = -150$ mA	(V+) -2.1 (V-) +2.1 (V+) -3 (V-) +4 (V+) -4 (V-) +5	±250 (V+) -1.7 (V-) +1.8 (V+) -2.4 (V-) +3.5 (V+) -2.8 (V-) +4		* * * *	** ** ** **		mA V V V V
Short-Circuit Current			±350	±550		±400	*	mA
DYNAMIC RESPONSE Bandwidth, –3dB  Slew Rate Settling Time, 0.1% 1%  Differential Gain Differential Phase	$\begin{aligned} R_L &= 1 k \Omega \\ R_L &= 100 \Omega \\ 20 V p-p, \ R_L &= 100 \Omega \\ 20 V \ Step, \ R_L &= 100 \Omega \\ 20 V \ Step, \ R_L &= 100 \Omega \\ 3.58 MHz, \ V_O &= 0.7 V, \ R_L &= 150 \Omega \\ 3.58 MHz, \ V_O &= 0.7 V, \ R_L &= 150 \Omega \end{aligned}$		30 20 2000 200 50 4 2.5			180 160 * * * 0.4		MHz MHz V/μs ns ns °
POWER SUPPLY Specified Operating Voltage Operating Voltage Range Quiescent Current, I <sub>Q</sub>	l <sub>O</sub> = 0	±2,25 <sup>(2)</sup>	±15 ±1.5	±18 ±2	*	* ±15	* ±20	V V mA
TEMPERATURE RANGE Specification Operating Storage Thermal Shutdown		-40 -40 -55		+85 +125 +125	* *		* *	°C °C °C
Temperature, $T_J$ Thermal Resistance, $\theta_{JA}$ $\theta_{JA}$ $\theta_{JA}$ $\theta_{JC}$ $\theta_{JA}$	"P" Package(3) "U" Package(3) "T" Package(3) "T" Package "F" Package(3) "F" Package(3)		175 100 150 65 6 65 6			* * * * * * *		°C °C/W °C/W °C/W °C/W °C/W °C/W °C/W
		V <sub>IN</sub> V <sub>O</sub> V <sub>O</sub> V <sub>O</sub>		V <sub>iN</sub> V <sub>o</sub> O				

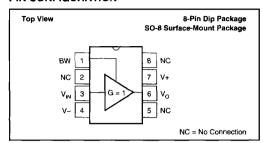
<sup>\*</sup> Specifications the same as Low Quiescent Mode.

NOTES: (1) Tests are performed on high speed automatic test equipment, at approximately 25°C junction temperature. The power dissipation of this product will cause some parameters to shift when warmed up. See typical performance curves for over-temperature performance. (2) Limited output swing available at low supply voltage. See Output voltage specifications. (3) Typical when all leads are soldered to a circuit board. See text for recommendations.

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## Or, Call Customer Service at 1-800-548-6132 (USA Only)

#### PIN CONFIGURATION



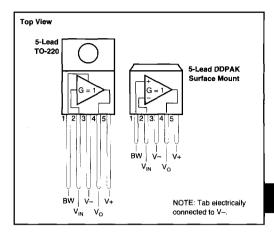
#### **ABSOLUTE MAXIMUM RATINGS**

Supply Voltage	±V <sub>S</sub>
Storage Temperature	55°C to +125°C
Junction Temperature	
Lead Temperature (soldering,10s)	+300°C

#### **PACKAGE/ORDERING INFORMATION**

PRODUCT	PACKAGE	PACKAGE DRAWING NUMBER <sup>(1)</sup>	TEMPERATURE RANGE
BUF634P	8-Pin Plastic DIP	006	-40°C to +85°C
BUF634U	SO-8 Surface-Mount	182	-40°C to +85°C
BUF634T	5-Lead TO-220	315	-40°C to +85°C
BUF634F	5-Lead DDPAK	325	-40°C to +85°C

NOTE: (1) For detailed drawing and dimension table, please see end of data sheet, or Appendix C of Burr-Brown IC Data Book.



# ELECTROSTATIC DISCHARGE SENSITIVITY

Any integrated circuit can be damaged by ESD. Burr-Brown recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet published specifications.

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